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pci6023e

pci6024e daqcard6024e

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pxi6025e

Low-Cost E Series Multifunction DAQ – 200 kS/s, 12-Bit, 16 Analog Inputs

NI 6023E, NI 6024E, NI 6025E

NI 6023E

PCI-6023E

NI 6024E

PCI-6024E

DAQCard-6024E

NI 6025E

PCI-6025E PXI-6025E

Analog Inputs

16 single-ended, 8 differential channels 200 kS/s sampling rate 200 kS/s stream-to-disk rate

12-bit resolution

Analog Output

(NI 6024E and NI 6025E only) 2 channels, 12-bit resolution

Digital I/O

8 (5 V/TTL) lines (6023E and 6024E) 32 (5 V/TTL) lines (6025E)

Counter/Timers

2 up/down, 24-bit resolution

Triggering

Digital

Real-Time

See page 184. **Driver Software**

NI-DAO

Windows 2000/NT/Me/9x Mac OS - not for all hardware

Application Software

LabVIEW Measure VirtualBench Lookout Measurement Studio

Calibration Certificate Included

See page 256.



Ordering Information

NI 6023E

PCI-6023E 777742-01

NI 6024E

NI 6025E

Includes NI-DAQ for Windows 2000/NT/Me/9x and Mac OS unless otherwise noted. *Windows only

Extended warranty and

value added services...

Recommended Configurations

Family	DAQ Device	Accessory	Cable
NI 6023E	PCI-6023E	CB-68LP (777145-01)	R6868 (182482-01)
NI 6024E	PCI-6024E	CB-68LP (777145-01)	R6868 (182482-01)
	DAQCard-6024E	CB-68LP (777145-01)	RC68-68 (187252-01)
NI 6025E	PCI-6025E	Two CB-50LPs (777101-01)	R1005050 (182762-01)
	PXI-6025E	Two CB-50LPs (777101-01)	R1005050 (182762-01)

See page 334 for accessory and cable information.

Overview

The NI 6023E, NI 6024E, and NI 6025E are our low-cost 12-bit DAQ devices that use E Series technology to deliver high performance and reliable data acquisition capabilities in a wide range of applications. You get up to 200 kS/s, 12-bit performance on 16 single-ended analog inputs. Depending on your type of hard drive, these devices can stream to disk at rates up to 200 kS/s. The new DAQCard-6024E gives you the same performance in a PCMCIA card for portable application needs.

These E Series devices feature digital triggering capability, as well as two 24-bit, 20 MHz counter/timers; and 8 digital I/O lines. The NI 6024E and NI 6025E also feature two 12-bit analog outputs. An additional 24 lines of 5 V/TTL I/O makes the NI 6025E family the best value of any PCI data acquisition

See the E Series Multifunction DAQ Overview on page 306 for a more detailed hardware overview.

		Analog		Sampling	Input	Analog		Output	Output	Digital	Counter/	
Family	Bus	Inputs	Resolution	Rate	Range	Outputs	Resolution	Rate	Range	I/O	Timers	Triggers
NI 6023E	PCI	16 SE/8 DI	12 bits	200 kS/s	±0.05 to ±10 V	-	-	1	1	8	2, 24-bit	Digital
NI 6024E	PCI, PCMCIA	16 SE/8 DI	12 bits	200 kS/s	±0.05 to ±10 V	2	12 bits	10 kS/s ¹	±10 V	8	2, 24-bit	Digital
NI 6025E	PCI, PXI,	16 SE/8 DI	12 bits	200 kS/s	±0.05 to ±10 V	2	12 bits	10 kS/s ¹	±10 V	32	2, 24-bit	Digital
	CompactPCI											
1 10 kS/s syster	10 kS/s system-dependent when using the single DMA channel for analog output. 1 kS/s system-dependent when using the single DMA channel for either analog input or counter/timer operations.											

Table 1. NI 6023E, NI 6024E, and NI 6025E Channel, Speed, and Resolution Specifications (see page 344 for detailed specifications)

Low-Cost E Series Multifunction DAQ – 200 kS/s, 12-Bit, 16 Analog Inputs

Absolute Accuracy									Relative /	Accuracy
Nominal Range (V) % of Reading				Noise + Quar	tization (mV)	Temp	Absolute Accuracy	Resoluti	on (mV)	
Positive FS	Negative FS	24 Hrs	1 Year	Offset (mV)	Single Pt.	Averaged	Drift (%/°C)	at Full Scale (mV)	Single Pt.	Averaged
10	-10	0.0872	0.0914	6.38	3.91	0.975	0.0010	16.504	5.89	1.28
5	-5	0.0272	0.0314	3.20	1.95	0.488	0.0005	5.263	2.95	0.642
0.5	-0.5	0.0872	0.0914	0.340	0.195	0.049	0.0010	0.846	0.295	0.064
0.05	-0.05	0.0872	0.0914	0.054	0.063	0.006	0.0010	0.106	0.073	0.008

Note: Accuracies are valid for measurements following an internal E Series Calibration. Averaged numbers assume dithering and averaging of 100 single-channel readings.

Measurement accuracies are listed for operational temperatures within ±1 °C of internal calibration temperature and ±10 °C of external or factory-calibration temperature. One-year calibration interval recommended. The Absolute Accuracy at Full Scale calculations were performed for a maximum range input voltage (for example, 10 V for the ±10 V range) after one year, assuming 100 pt averaging of data. See overview on page 312 for an example calculation of this type.

Table 2. NI 6023E, PCI-6024E, and NI 6025E Analog Input Accuracy Specifications

Absolute Accuracy								Relative Accuracy		
Nominal	Nominal Range (V)		ige (V) % of Reading			ntization (mV)	Temp	Absolute Accuracy	Resoluti	ion (mV)
Positive FS	Negative FS	24 Hrs	1 Year	Offset (mV)	Single Pt.	Averaged	Drift (%/°C)	at Full Scale (mV)	Single Pt.	Averaged
10	-10	0.0872	0.0914	8.83	3.91	1.042	0.0010	19.012	5.89	1.37
5	-5	0.0272	0.0314	4.42	1.95	0.521	0.0005	6.517	2.95	0.686
0.5	-0.5	0.0872	0.0914	0.462	0.452	0.052	0.0010	0.972	0.516	0.069
0.05	-0.05	0.0872	0.0914	0.066	0.063	0.007	0.0010	0.119	0.073	0.009

Note: Accuracies are valid for measurements following an internal E Series Calibration. Averaged numbers assume dithering and averaging of 100 single-channel readings.

Measurement accuracies are listed for operational temperatures within ±1 °C of internal calibration temperature and ±10 °C of external or factory-calibration temperature. One-year calibration interval recommended. The Absolute Accuracy at Full Scale calculations were performed for a maximum range input voltage (for example, 10 V for the ±10 V range) after one year, assuming 100 pt averaging of data. See overview on page 312 for an example calculation of this type.

Table 3. DAQCard-6024E Analog Input Accuracy Specifications

Nomin	al Range (V)		Absolute Accuracy				
		% of Reading				Temp	Accuracy at
Positive FS	Negative FS	ve FS 24 Hrs 90 Days 1 Year		1 Year	Offset (mV)	Drift (%/°C)	Full Scale (mV)
10 -10 0.0177 0.0197 0.0219						0.0005	8.127
Note: Temp D	Note: Temp Drift applies only if ambient is greater than ±10 °C of previous external calibration. See page 312 for example calculations.						

Table 4. NI 6023E, PCI-6024E, and NI 6025E Analog Output Accuracy Specifications

Nomina	al Range (V)		Absolute Accuracy					
		% of Reading				Temp	Accuracy at	
Positive FS Negative FS		24 Hrs	90 Days	1 Year	Offset (mV)	Drift (%/°C)	Full Scale (mV)	
10	-10	0.0177	0.0197	0.0219	8.37	0.0005	10.568	
Note: Temp Drift applies only if ambient is greater than ±10 °C of previous external calibration. See page 312 for example calculations.								

Table 5. DAQCard-6024E Analog Output Accuracy Specifications

	Analog Input				Analog Output		Available	PCI Bus
Product	Sample Rate	Polarity	Range Selections	Update Rate	Polarity	FIFO Size	DMA Channels	Master
PCI-6023E/6024E/6025E	200 kS/s	Bipolar	20 V, 10 V, 1 V, 100 mV	Up to 10 kS/s ¹	Bipolar	_	1	✓
PCI-6040E	250 kS/s	Unipolar	20 V, 10 V, 5 V, 2 V, 1 V	Up to 1 MS/s	Unipolar	512 Samples	3	✓
		or Bipolar	500 mV, 200 mV, 100 mV		or Bipolar			
PCI-6070E	1.25 MS/s	Unipolar	20 V, 10 V, 5 V, 2 V, 1 V	Up to 1 MS/s	Unipolar	2,048 Samples	3	✓
		or Bipolar	500 mV, 200 mV, 100 mV		or Bipolar			
1 10 kS/s system-dependent who	en using the single	DMA channel fo	or analog output. 1 kS/s system-dep	endent when using the single	DMA channel for either a	nalog input or counter/tin	ner operations.	

Table 6. How To Choose Between the PCI-6024E, PCI-6040E, and PCI-6070E DAQ Devices. This table highlights the differences

between these product families. Use the table to determine which device has the features your application requires.

Visit ni.com/info and enter ex6q2w to find block diagrams in the user manuals for the NI 6023E, NI 6024E, and NI 6025E devices.



See page 310 in the E Series Multifunction DAQ Overview for I/O connector diagrams.



See page 344 for more detailed specifications.

E Series Multifunction DAQ Specifications

12-Bit E Series (NI 607xE, NI 606xE, NI 604xE, NI 602xE)

These specifications are typical for 25 °C unless otherwise noted.

Analog Input

Accuracy specifications See tables in E Series Product pages.

Input Characteristics

Number of channels

6070E	16 single-ended or 8 differential
6060E	(software selectable per channel)
6062E	
604xE	
602xE	
6071E	64 single-ended or 32 differential
6061E	(software selectable per channel)

Maximum sampling rate

607xE	1.25 MS/s
606xE	500 kS/s
604xE	500 kS/s single-channel scanning
	250 kS/s multichannel scanning
6061E	500 kS/s single-channel scanning
	333 kS/s multichannel
6023E	200 kS/s
6024E	
6025E	
6020E	100 kS/s
6021E	

Streaming-to-disk rate (system dependent)

DAQPad-6020E rates with SCSI or DMA-enabled EIDE.

607xE	1.25 MS/s		
606xE	500 kS/s		
604xE	250 kS/s		
6023E	200 kS/s		
6024E			
6025E			
6020E	100 kS/s²		
6021E			
'Streaming-to-disk rates do not apply to RT Series devices.			

Input signal ranges

Device	Range	Input	Range
	(Software Selectable)	Bipolar	Unipolar
607xE	20 V	±10 V	-
606xE	10 V	±5 V	0 to 10 V
604xE	5 V	±2.5 V	0 to 5 V
6020E	2 V	±1 V	0 to 2 V
6021E	1 V	±500 mV	0 to 1 V
	500 mV	±250 mV	0 to 500 mV
	200 mV	±100 mV	0 to 200 mV
	100 mV	±50 mV	0 to 100 mV
6023E	20 V	±10 V	-
6024E	10 V	±5 V	_
6025E	1 V	±500 mV	_
	100 mV	±50 mV	_

Overvoltage protection

Device	Powered On	Powered Off
607xE	±25 V	±15 V
606xE		
604xE		
6023E	±40 V	±25 V
6024E		
6025E		
6020E	±35 V	±25 V
6021E		

Inputs protected

6070E, 6060E	ACH<015>, AISENSE
6062E, 604xE	
602xE	
6071E, 6061E	ACH<063>, AISENSE, AISENSE2
	6062E, 604xE 602xE

FIFO buffer size

AT-MIO-16E-1	8,192 samples
DAQCard-6062E	
DAQPad-6020E	4,096 samples
6060E/6061E	2,048 samples
DAQPad-6070E	·
DAQCard-6024E	
6041E	1,024 samples
PCI-MIO-16E-1	512 samples
PXI-6070E	
6071E, 6040E	
PCI-602xE	
(except DAQPad)	
PXI-6025E	

Data transfers

	PCI, PXI, AT, DAQPad for IEEE 1394	DMA, interrupts, programmed I/O
	DAQCard, DAQPad for USB	Interrupts, programmed I/O
DI	VIA modes	
	PCI, PXI, DAQPad for IEEE 1394	Scatter-gather (single-transfer, demand
		transfer)
	AT	Single transfer, demand transfer
C	onfiguration memory size	512 words

Transfer Characteristics

Relative accuracy

Device	Typical Dithered	Maximum Undithered
607xE	±0.5 LSB	±1.5 LSB
606xE		
604xE		
6023E		
6024E		
6025E		
6020E	±0.2 LSB	±1.5 LSB
6021E		

DNL

Device	Typical	Maximum
607xE	±0.5 LSB	±1.0 LSB
6060E		
6061E		
604xE		
6023E		
PCI-6024E		
6025E		
6020E	±0.2 LSB	±1.0 LSB
6021E		
6062E	±0.75 LSB	-0.9, +1.5 LSB
DAQCard-6024E		

E Series Multifunction DAQ Specifications

12-Bit E Series (NI 607xE, NI 606xE, NI 604xE, NI 602xE) (continued)

Amplifier Characteristics

Input impedance

Device	Normal Powered On	Powered Off	Overload
6070E	100 GΩ in parallel	820 Ω	820 Ω
606xE	with 100 pF		
6040E			
PCI-6071E			
PXI-6071E			
6041E	100 GΩ in parallel	1 kΩ	1 kΩ
	with 100 pF		
602xE	100 G Ω in parallel	4.7 kΩ	4.7 kΩ
	with 100 pF		

 Input bias current
 ±200 pA

 Input offset current
 ±100 pA

CMRR, DC to 60 Hz

Device	Range	CMRR	
607xE	20 V	95 dB	
6060E	10 V	100 dB	
6061E	100 mV to 5 V	106 dB	
604xE	10 to 20 V	85 dB	
6062E	5 V	95 dB	
	100 mV to 2 V	100 dB	
6023E	10 to 20 V	85 dB	
6024E	100 mV to 1 V	90 dB	
6025E			
6020E	100 mV to 20 V	90 dB	
6021E			

Dynamic Characteristics

Bandwidth

Balldwidth			
Device	Small Signal (-3 dB)	Large Signal (1% THD)	
607xE	1.6 MHz	1 MHz	
6060E/6061E	1 MHz	300 kHz	
6062E	1.3 MHz	250 kHz	
6041E	800 kHz	400 kHz	
6040E	600 kHz	350 kHz	
6023E	500 kHz	225 kHz	
PCI-6024E			
6025E			
DAQCard-6024E	500 kHz	265 kHz	
6021E	150 kHz	120 kHz	

Settling time to full-scale step

		Accuracy		
		±0.012%	±0.024%	±0.098%
Device	Range	(±0.5 LSB)	(±1 LSB)	(±4 LSB)
6070E	20 V	2 µs typical	1.5 µs typical	1.5 µs typical
		3 µs max	2 µs max	2 µs max
	10 V	2 µs typical	1.5 µs typical	1.3 µs typical
		3 µs max	2 µs max	1.5 µs max
	200 mV to 5 V	2 µs typical	1.5 µs typical	0.9 µs typical
		3 µs max	2 µs max	1 µs max
	100 mV	2 µs typical	1.5 µs typical	1 µs typical
		3 µs max	2 µs max	1.5 µs max
PCI-6071E	20 V	3 µs typical	1.9 µs typical	1.9 µs typical
PXI-6071E		5 µs max	2.5 µs max	2 µs max
	10 V	3 µs typical	1.9 µs typical	1.2 µs typical
		5 µs max	2.5 µs max	1.5 µs max
	200 mV to 5 V	3 µs typical	1.9 µs typical	1.2 µs typical
		5 µs max	2.5 µs max	1.3 µs max
	100 mV	3 µs typical	1.9 µs typical	1.2 µs typical
		5 µs max	2.5 µs max	1.5 µs max
6060E	All	2 µs typical	1.9 µs typical	1.8 µs typical
		4 µs max	2 µs max	2 µs max
6061E		5 µs max	3 µs max	2 µs max
6062E	All	2.5 µs typical	2.5 µs typical	2 µs typical
		4 µs max	3 µs max	2.5 µs max
604xE	All	4 µs typical	4 µs max	4 µs max
		8 µs max		
6023E	All	5 μs typical	5 µs max	5 µs max
6024E				
6025E				
6020E	All	10 µs max	10 µs max	10 µs max
6021E				

System noise (LSBrms, not including quantization)

Device	Range	Dither Off	Dither On
6070E	1 to 20 V	0.25	0.5
PCI-6071E	500 mV	0.4	0.6
PXI-6071E	200 mV	0.5	0.7
	100 mV	0.8	0.9
6060E	200 mV	0.3	0.6
6061E	100 mV	0.5	0.7
6062E	1 to 20 V	0.25	0.6
	500 mV	0.4	0.75
	200 mV	0.5	0.8
	100 mV	0.8	1.0
604xE	1 to 20 V	0.2	0.5
	500 mV	0.25	0.5
	200 mV	0.5	0.7
	100 mV	0.9	1.0
6023E	1 to 20 V	0.1	0.6
PCI-6024E, 6025E	100 mV	0.7	0.8
DAQCard-6024E	10 to 20 V	0.1	0.65
	1 V	0.45	0.65
	100 mV	0.70	0.90
6020E	1 to 20 V	0.07	0.5
6021E	500 mV	0.12	0.5
	200 mV	0.25	0.6
	100 mV	0.5	0.7

Crosstalk, DC to 100 KHz

CIOSSIAIK, DC to 100 kHz				
Device	Adjacent Channels	All Other Channels		
607xE, 606xE, 604xE	-75 dB	-90 dB		
602xE	-60 dB	-80 dB		

E Series Multifunction DAQ Specifications

12-Bit E Series (NI 607xE, NI 606xE, NI 604xE, NI 602xE) (continued)

Analog Output

	-9	
Output	Charac	cteristic

radifiber of charifie	•
607xE	2 voltage outputs
606xE	
6040E	
6020E	
6021E	
6024E	
6025E	
6041E	None
6023E	
Posolution	12 bits 1 in 4094

Maximum update rate

Device	Waveform Generation			
	FIFO Mode		Non-FIF	O Mode
	Internally Timed	Externally Timed	1 Channel	2 Channels
607xE	1 MS/s	950 kS/s	800 kS/s,	400 kS/s,
6060E, 6061E			system dependent	system dependent
6040E				
6062E	850 kS/s	850 kS/s	800 kS/s,	400 kS/s,
			system dependent	system dependent
6023E	N/A	N/A	10 kS/s with DMA	10 kS/s with DMA
			1 kS/s with interrupts	1 kS/s with interrupts
PCI-6024E			system dependent	system dependent
6025E				
DAQCard-6024E	N/A	N/A	1 kS/s with interrupts	1 kS/s with interrupts
			system dependent	system dependent
6020E; except	N/A	N/A	100 kS/s,	100 kS/s,
DAQPad-6020E			system dependent	system dependent
DAQPad-6020E	N/A	N/A	20 S/s,	20 S/s,
			system dependent	system dependent

FIFO buffer size

607xE, 606xE	2,048 samples
6040E	512 samples
602xE	None

..... Single transfer, demand transfer

ata transfer

Data transfers	
PCI, PXI, AT, DAQPad for IEEE 1394	DMA, interrupts, programmed I/O
DAQCard, DAQPad for USB	Interrupts, programmed I/O
DMA modes	
PCI, PXI, DAQPad	Scatter-gather (single transfer,
	demand transfer)

Transfer Characteristics

Relative accuracy

After calibration (6062E,	
DAQCard-6024E)	±0.5 LSB typical, ±1.0 LSB max
After calibration (all others)	±0.3 LSB typical, ±0.5 LSB max
Before calibration	±4 LSB max
DNL	
After calibration (6062E,	
DAQCard-6024E)	±0.5 LSB typical, ±1.0 LSB max
After calibration (all others)	±0.3 LSB typical, ±1.0 LSB max

Voltage Output

Ranges

607xE, 6060E 6061E, 6040E 6020E, 6021E	±10 V, 0 to 10 V, ±EXTREF, 0 to EXTREF; software selectable
6062E	±10 V, ±EXTREF, software selectable
6020E, 6021E 6024E, 6025E	±10 V

Output coupling	DC
Output impedance	0.1 Ω max
Current drive	±5 mA max
Protection	Short-circuit to ground
Power-on state	0 V (±200 mV)

External reference input (not available on 6024E or 6025E)

Overvoltage protection

- 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1	
607xE	±25 V powered on, ±15 V powered off
606xE	
604xE	
602xE	±35 V powered on, ±25 V powered off

Input impedance 10 kg

Bandwidth (-3 dB)

607xE	1 MHz
6060E, 6061E	
604xE	
6062E	50 kHz
602xE	300 kHz

Dynamic Characteristics

Settling time and slew rate

Device	Settling Time for Full-Scale Step	Slew Rate
607xE	3 µs to ±0.5 LSB accuracy	20 V/µs
606xE		
6040E		
602xE	10 μs to ±0.5 LSB accuracy	10 V/μs

Glitch energy (at mid-scale transition)

Magnitude

Di	Daulitakian Biaakiad	Destitution Factors
Device	Reglitching Disabled	Reglitching Enabled
DAQPad-6070E	±20 mV	±4 mV
PCI-MIO-16E-1		
PCI-6071E		
PXI-6070E		
PXI-6071E		
AT-MIO-16E-1	±200 mV	±30 mV
6060E, 6061E		
604xE		
PCI-6024E	±42 mV	N/A
6025E		
DAQCard-6024E	± 13 mV	N/A
6020E	±100 mV	N/A
6021E		
6062E	±80 mV	±30 mV

Duration

607xE	1.5 µs
6060E, 6061E	
604xE	
6024E	2 μs
6025E	
6020E	3 µs
6021E	
6062E	

Stability

Gain temperature coefficient

External reference ±25 ppm/°C

Digital I/O

Number of channels

6021E	32 input/output
6025E	
All others	8 input/output

E Series Multifunction DAQ Specifications

12-Bit E Series (NI 607xE, NI 606xE, NI 604xE, NI 602xE) (continued)

..... 5 V/TTL Power-on state Input; high impedance Digital logic levels

DIO<0..7> on all devices

PA<0..7>, PB<0..7>, PC<0..7> on remaining 24 lines of 6021E and 6025E

Level	Minimum	Maximum
Input low voltage	0 V	0.8 V
Input high voltage	2 V	5 V
Output low voltage (I _{out} = 24 mA)	-	0.4 V
Output high voltage (I _{out} = 13 mA)	4.35 V	-

Level	Minimum	Maximum
Input low voltage	0 V	0.8 V
Input high voltage	2 V	5 V
Output low voltage (I _{out} = 2.5 mA)	-	0.4 V
Output high voltage (I _{out} = 2.5 mÅ)	3.9 V	_

Data transfers

6021E	Interrupts, programmed I/O
6025E	
All others	Programmed I/O

Handshaking (6021E and 6025E only)

Modes....

Transfer rate (1 word = 8 bits)

Maximum with NI-DAQ™, system dependent

				_
	DAQPad-6070E	l 5 kwords/s		
- 1-				_
	All others	50 kwords/s		
_	•			_
	Constant sustainable rate.		1 to 10 kwords/s, typical	

Timing I/0

General-Purpose Up/Down Counter/Timers

Number of channels	2
Resolution	24 bits
Compatibility	5 V/TTL
Digital logic levels	

Le	vel	Minimum	Maximum
Inp	out low voltage	0 V	0.8 V
Ing	out high voltage	2 V	5 V
0ι	tput low voltage (I _{out} = 5 mA)	-	0.4 V
00	tput high voltage (I _{out} = 3.5 mA)	4.35 V	_

п	out	
	Base clocks available	20 MHz and 100 kHz
	Base clock accuracy	±0.01%
	Maximum source frequency	20 MHz
	External source selections'	 PFI0PFI9, RTSI0RTSI6, analog trigger; software selectable
	External gate selections'	 PFI0PFI9, RTSI0RTSI6, analog trigger; software selectable
	Minimum source pulse duration	10 ns
	Minimum gate pulse duration	10 ns, edge-detect mode
	Data transfers	
	PCI, PXI, AT, DAQPad for IEEE 1394	DMA, interrupts, programmed I/O
	DAQCard, DAQPad for USB	Interrupts, programmed I/O
	DMA modes	
	PCI, PXI, DAQPad for IEEE 1394	 Scatter-gather (single transfer, demand transfer)
	AT	Single transfer, demand transfer

Frequency Scaler

Number of channels	1
Resolution	4 bits
Compatibility	5 V/TTL
District Control of	

Digital logic levels

Level	Minimum	Maximum
Input low voltage	0 V	0.8 V
Input high voltage	2 V	5 V
Output low voltage (I _{out} = 5 mA)	-	0.4 V
Output high voltage (I _{out} = 3.5 mA)	4.35 V	-

Base clocks available	10 MHz, 100 kHz
Base clock accuracy	±0.01%
Data transfers	Programmed I/O

Triggers Analog Triggers

Number of triagers

607xE	1
606xE	
604xE	
602xE	None

..... Start and stop trigger, gate, clock Analog output...... Start trigger, gate, clock General-purpose counter/timers Source, gate

6070E	ACH<015>, PFI0/TRIG1
6062E, 6060E	
604xE,	
602xE	
6071E	ACH<063>, PFI0/TRIG1
6061E	

Internal source, ACH<015/63>	±Full-scale
External source, PFIO/TRIG1	±10 V
Slope	Positive or negative; software selectable
Resolution	8 bits, 1 in 256

Bandwidth (-3 dB)

, ,				
Device	Internal Source	External Source		
607xE	2 MHz	7 MHz		
6060E, 6061E	1 MHz	7 MHz		
6062E	500 kHz	2.5 MHz		
604xE	2 MHz	3 MHz		

Programmable ±5% of full-scale range max

Digital Triggers (all devices)

Number of triggers	2
Purpose	
Analog input	Start and stop trigger, gate, clock
Analog output	Start trigger, gate, clock
General-purpose counter/timers	Source, gate
Source'	PFIOPFI9, RTSIORTSI6
Slope	Positive or negative; software selectable
Compatibility	5 V/TTL
Response	Rising or falling edge
Pulse width	10 ns minimum
External input for digital or analog trigger	(PFIO/TRIG1)
Impedance	
6062E	12 kΩ
All others	10 kΩ
Coupling	DC
Protection	
Digital trigger	-0.5 to Vcc + 0.5 V
Analog trigger	
On/off/disabled	±35 V

Calibration	
Recommended warm-up time	15 minutes; 30 minutes for DAQCard and DAQPad
Calibration interval	1 year
Onboard calibration reference	
DC level	5.000 V (±3.5 mV) over full operating temperatures, actual value stored in EEPROM
Temperature coefficient Long-term stability	

E Series Multifunction DAQ Specifications -

12-Bit E Series (NI 607xE, NI 606xE, NI 604xE, NI 602xE) (continued)

RTSI (PCI, DAQPad-6070E for IEEE 1394, and ISA only) PXI Trigger Bus (PXI only) Trigger lines 6 Star trigger 1

Bus Interface

PCI, PXI, DAQPad for IEEE 1394...... Master, slave AT, DAQCard, DAQPad for USB...... Slave

Power Requirements²

Device	+5 VDC (±5%)*	Power Available at I/O Connector			
607xE	1.1 A	+4.65 to +5.25 VDC, 1 A			
6060E, 6061E	1.0 A	+4.65 to +5.25 VDC, 1 A			
6040E					
602xE, (except DAQPad	0.7 A	+4.65 to +5.25 VDC, 1 A			
and DAQCard)					
DAQCard-6062E	340 mA typical	+4.65 to +5.25 VDC, 250 mA			
	750 mA maximum				
DAQCard-6024E	270 mA typical	±4.65 to +5.25 VDC, 250 mA			
	750 mA maximum				
DAQCard-AI-16E-4	280 mA typical	+4.65 to +5.25 VDC, 250 mA			
	400 mA maximum				

Device	Power	Power Available at I/O Connector		
DAQPad-6020E	15 W3, +9 to +30 VDC	+4.65 to +5.25 VDC, 1 A		
DAQPad-6070E	17 W3, +9 to +25 VDC	+4.65 to +5.25 VDC, 1 A		

Discharge time with BP-1 battery pack

*Excludes power consumed through I/O connector.

Physical²

Dimensions (not including connectors)

PCI² 17.5 by 9.9 c m (6.9 by 3.9 in.)

AT (long)	33.8 by 9.9 c m (13.3 by 3.9 in.)
AT (short)	17.5 by 9.9 c m (6.9 by 4.2 in.)
DAQPad (30 cm enclosure)	25.4 by 30.5 by 4.6 c m (10 by 12 by
	1.8 in.)
DAQPad (15 cm enclosure)	14.6 by 21.3 by 3.8 c m (5.8 by 8.4 by
	1.5 in.)
DAQCard	Type II PC Card

I/O connector²

O connector-	
6070E	68-pin male 0.050 D-type
6060E	
6040E	
6020E	
6023E	
PCI-6024E	
DAQCard-6062E,	68-pin female VHDCI
DAQCard-6024E	
6071E	100-pin female 0.050 D-type
6061E	
6021E	
6025E	
DAQCard-AI-16E-4	68-pin female PCMCIA
	6070E 6060E 6040E 6020E 6023E PCI-6024E DA0Card-6062E, DAQCard-6024E 6071E 6061E 6021E

Environment

Operating temperature	0 to 55 °C; 0 to 40 °C for			
	DAQCard-6062E and DAQCard-6024E			
	with a maximum internal temperature			
	of 70 °C as measured by onboard			
	temperature sensor; case temperature			
	should not exceed 55 °C for			
	any DAQCard			
Storage temperature	-20 to 70 °C			
Relative humidity	10 to 90%, noncondensing			

Certifications and Compliances CE Mark Compliance ←

- ¹ Refer to RTSI™ specifications for available RTSI trigger lines.
- 2 See page 184 for RT Series devices power requirements and dimensions.

Accuracy Specifications for Data Acquisition ————



Every Measurement Counts

There is no room for error in your measurements. From sensor to software, your system must deliver accurate results. NI provides detailed specifications for our products so that you do not have to guess how they will perform. Along with traditional data acquisition specifications, our E Series multifunction DAQ devices also include accuracy tables to assist you in selecting the appropriate hardware for your application. These tables are found on the product pages and include specifications for both absolute and relative accuracy.

Absolute Accuracy

Absolute accuracy is the specification you use to determine the overall maximum error of your measurement. Absolute accuracy specifications apply only to a successfully calibrated DAO device. There are four components of an absolute accuracy specification:

% of Reading is a percent of the actual input voltage.

Offset is a constant offset applied to all measurements.

Noise + Quantization is based on noise and depends on the number of points averaged for each measurement.

Drift is based on variations in your ambient temperature.

Based on these components, the formula for calculating absolute accuracy is:

Absolute Accuracy =
$$\pm$$
[(Input Voltage * % of Reading) + (Offset + Noise + Quantization + Drift)]

Drift is already accounted for unless your ambient temperature is outside +15 to +35 °C. For instance, if your ambient temperature is at 45 °C, you must account for 10 °C of drift. This is calculated by:

Drift = Temperature Difference * % Drift per °C * Input Voltage

Absolute Accuracy at Full Scale is a calculation of absolute accuracy for a specific voltage range using the maximum voltage within that range, the one year after calibration Accuracy Drift Reading and the Noise + Quantization averaged value.

Below is the **Absolute Accuracy at Full Scale** calculation for the PCI-MIO-16XE-50 after one year using the ± 10 V input range while averaging 100 samples of a 10 V input signal. In all the Absolute Accuracy at Full Scale calculations, we assume that the ambient temperature is between 15 and 35 °C. You can see on the next page that the calculation for the ± 10 V input range for Absolute Accuracy at Full Scale yields 1.443 mV. This calculation is done using the parameters in the same row for one year Absolute Accuracy Reading, Offset and Noise + Quantization as well as a value of 10 V for the input voltage value. You can then see that the calculation is as follows:

Absolute Accuracy = $\pm [(10 * 0.0001) + 397.2 \,\mu\text{V} + 45.8 \,\mu\text{V} = \pm 1.443 \,\text{mV}]$

The following example assumes the same conditions except that the ambient temperature is 45 °C. You can begin with the calculation above and add in the Drift calculation using the % Drift per °C from the table on the next page (see Table 1).

Absolute Accuracy = 1.443mV + ((45 °C - 35 °C) * 0.000002 / °C * 10 V)
=
$$\pm 1.643$$
 mV

If you are making single-point measurements, use the Single-Point Noise + Quantization specification from the accuracy tables. If you are averaging multiple points for each measurement, the value for Noise + Quantization changes. The Averaged Noise + Quantization in the accuracy tables assumes that you average 100 points per measurement. If you are averaging a different number of points, use the following equation to determine your Noise + Quantization:

Noise + Quantization for x averaged points = Averaged Noise + Quantization from table *
$$\sqrt{100/x}$$

For example, if you are averaging 1000 points per measurement with the PCI-MIO-16XE-50 in the ± 10 V input range, the Noise ± 10 Cuantization is determined by:

Noise + Quantization = 45.7
$$\mu$$
V * $\sqrt{100/1000}$ = 14.5 μ V

The Noise + Quantization specifications assume that dithering is disabled for single-point measurements and enabled for averaged measurements.



See page 256 or visit *ni.com/calibration* for more information on the importance of calibration on DAQ device accuracy.

Accuracy Specifications for Data Acquisition

Relative Accuracy

Relative accuracy is the specification that compares the difference between two or more measurements. It indicates the degree to which two or more measurements can be distinguished from each other. The two major contributors to relative accuracy are the resolution of the device ADC and the system noise. The accuracy tables show both single-point and averaged relative accuracy, which include both ADC resolution and system noise effects. Averaging will improve your relative accuracy for DC measurements.

As an example, assume you are monitoring a voltage once per second using the $\pm 10 \, \text{V}$ range on the PCI-MIO-16XE-50 and averaging 100 points for each measurement. Using the accuracy table on page 333 (reprinted below for your convenience), we find:

Averaged Relative Accuracy = $60.3 \mu V$

This means that a measurement taken at time t2 would have to be $60.3\,\mu\text{V}$ greater or less than the measurement taken at time t1 in order to detect a difference in the input voltage. Relative accuracy does not depend on DAQ device calibration.

Detailed Specifications

The pages starting at page 344 contain detailed specifications for all National Instruments E Series multifunction devices. Devices can be identified by their family number. For instance, if you want to determine the common-mode rejection ratio (CMRR) in the 10 V range for the PCI-6052E in unipolar range, you would look at the 16-bit E Series Multifunction DAQ specification on page 349. For the 10 V range the CMRR specification for the NI 6052E devices is 97 dB.

	Absolute Accuracy							Relative Accuracy			
Nominal		% of Reading		Offset	Offset Noise + Quantization (µV)		Temp Absolute Accuracy		Resolution (μV)		
	Range (V)	24 Hrs	90 Days	1 Year	(μV)	Single Pt.	Averaged	Drift (%/°C)	at Full Scale (mV)	Single Pt.	Averaged
	±10	0.0058%	0.0078%	0.0100%	397.2	526.4	45.8	0.0002	1.443	602.7	60.3
ad	±5	0.0208%	0.0228%	0.0250%	200.6	263.2	22.9	0.0007	1.474	301.4	30.1
and DAQPad	±1	0.0208%	0.0228%	0.0250%	43.3	52.6	4.6	0.0007	0.298	60.3	6.0
d D	±0.1	0.0408%	0.0428%	0.0450%	7.9	8.4	0.7	0.0012	0.054	9.6	1.0
ľ, an	0 to 10	0.0058%	0.0078%	0.0100%	244.6	263.2	22.9	0.0002	1.268	301.4	30.1
PCI, AT,	0 to 5	0.0208%	0.0228%	0.0250%	124.3	131.6	11.4	0.0007	1.386	150.7	15.1
100	0 to 1	0.0208%	0.0228%	0.0250%	28.1	26.3	2.3	0.0007	0.280	30.1	3.0
	0 to 0.1	0.0408%	0.0428%	0.0450%	6.4	7.0	0.6	0.0012	0.052	8.4	0.8
	±10	0.0075%	0.0095%	0.0117%	815.4	1029.1	91.6	0.0005	2.077	1205.4	120.5
	±5	0.0225%	0.0245%	0.0267%	409.7	514.6	45.8	0.0010	1.791	602.7	60.3
_	±1	0.0225%	0.0245%	0.0267%	85.1	102.9	9.2	0.0010	0.361	120.5	12.1
DAQCard	±0.1	0.0425%	0.0445%	0.0467%	12.1	12.2	1.1	0.0015	0.060	14.5	1.4
AO	0 to 10	0.0075%	0.0095%	0.0117%	591.2	514.6	45.8	0.0005	1.807	602.7	60.3
Γ	0 to 5	0.0225%	0.0245%	0.0267%	297.6	257.3	22.9	0.0010	1.656	301.4	30.1
	0 to 1	0.0225%	0.0245%	0.0267%	62.7	51.5	4.6	0.0010	0.334	60.3	6.0
	0 to 0.1	0.0425%	0.0445%	0.0467%	9.9	8.0	0.7	0.0015	0.057	9.6	1.0

Note: Accuracies are valid for measurements following an internal E Series calibration. Averaged numbers assume dithering and averaging of 100 single-channel readings. Measurement accuracies are listed for operational temperatures within ±1 °C of internal calibration temperature and ±10 °C of external or factory-calibration temperature. One-year calibration interval recommended. The Absolute Accuracy at Full Scale calculations were performed for a maximum range input voltage value (for example, 10 V for the ±10 V range) after one year assuming 100 pt averaging of data. See the overview on page 312 for an example calculation of this type.

Table 1. NI 601xE Analog Input Accuracy Specifications